

Regulated Switched Capacitor LED Current Source with Analog and PWM Brightness Control

General Description

The EMD2794/EMD2795 is a 1.5x/1.0x charge pump that provides four regulated current sources. It accepts an input voltage range from 2.7V to 5.5V and maintains a constant current determined by an external resistor.

The EMD2794/EMD2795 delivers up to 80mA of load current to accommodate four White LEDs. The switching frequency is fixed at 1.2MHz to make noise filtering easier. Brightness control can be done by both linear and PWM techniques. Linear control is achieved by applying 0V to 3.0V to the BRGT pin to linearly vary the LED current. PWM technique is to apply a clock to the EN pin to having brightness varying with clock duty.

Shutdown is done by applying low (high for 2795) to the pin EN. The VIN current drops to less than 1.0uA in shutdown mode.

The EMD2794/EMD2795 is available in a TQFN-16 & FBP-16 3x3 package.

Features

- Regulated current sources with ±0.5% matching between any two outputs
- High efficiency 3/2 boost function
- Drives one to four white LEDs.
- 2.7V to 5.5V input range
- Up to 80mA output current
- Analog brightness control
- Active-low or high shutdown input ('94/95)
- Very small solution size and no inductor
- Shutdown Current < 1μA</p>
- 1.2MHz switching frequency
- Constant frequency generates predictable noise spectrum
- QFN16 3x3 package

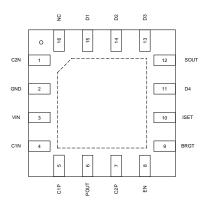
Applications

- White LED Display Backlights
- White LED Keypad Backlights
- 1-Cell Li-Ion battery-operated equipment including PDAs, hand-held PCs, cellular phones.



Connection Diagram

TQFN-16

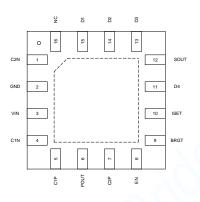


Order information

EMD2794-00HB16NRR / EMD2795-00HB16NRR

- 00 Voltage Option
- HB16 TQFN-16 Package
- N Green ; (RoHS & Halogen free)
- R Commercial Grade Temperature Rating: -40 to 85°C
- R Package in Tape & Reel

FBP-16



EMD2794-00BA16GRR / EMD2795-00BA16GRR

00	Voltage Option
BA16	FBP-16 Package
G	RoHS(Pb free)
R	Commercial Grade Temperature
	Rating: -40 to 85°C
R	Package in Tape & Reel



Marking & Packing Information

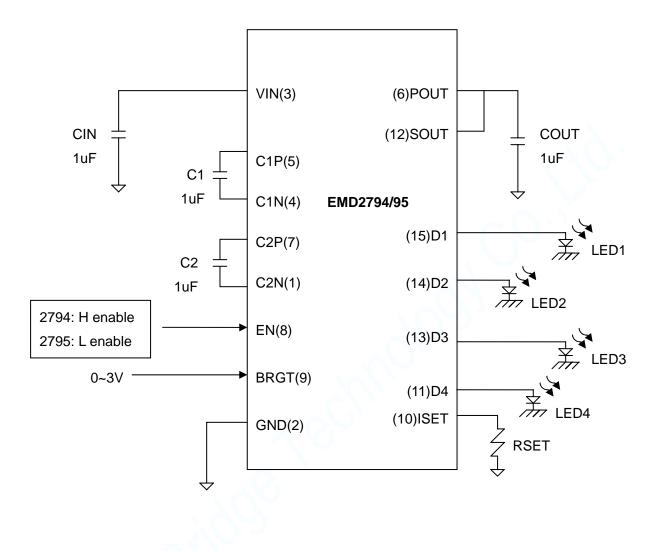
Product ID	Package Type	Product ID	Package Marking	Transport Media
EMD2794	TQFN-16	EMD2794-00HB16NRR		
EMD2774	FBP-16	emd2794-00BA16GRR		
ENIDOZOE	TQFN-16	By Request	1 1 1 1 (1) 1 1 1 1 (2) 1 1 1 1 1 1 1 (2) 1 1 1 1 1 1 1 1 (2) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	FK units Toppe & Deel
EMD2795	FBP-16	By Request		5K units Tape & Reel

YY: Year Code

WW: Weekly Code



Typical Applications





Absolute Maximum Ratings (Note 1)

V _{IN}		-0.5 to 6.2V
EN		-0.5 to 6.2V
BRGT	-0.5 to r	nin[(VIN+0.3), 6.2V]
Continuous Power Dissipation	(Note 2)	Internally Limited
T _{JMAX} (Note 2)		135°C
Storage Temeprature		-60°C to +150°C
Lead Temp. (Soldering, 5 sec.)		260°C

ESD Rating

Human Body Model	2kV
Machine Model	200V

Recommended Operating Conditions

V _{IN}	2.7 to 5.5V
Ambient Temperature (TA)	-30C to +85C
Junction Temperature (Tj)	-30C to +100C

Electrical Characteristics

Limits in standard typeface are for TJ=25°C and limits in **boldface type** apply over the full **Operating Junction Temperature Range** (-30°C \leq TJ \leq +100°C). Unless otherwise specified, C₁=C₂=C_{IN}=C_{OUT}=1 uF, V_{IN}=3.6V, BRGT pin =0V; R_{SET}=124 Ω ; EMD2794:

Symbol	Parameter	Conditions	Min	Тур	Max	Units	Note
I _{DX} Available current		$3.0V \leq V_{IN} \leq 5.5V$	5	16.7		mA	
		V _{DX} ≦3.8V, BRGT=50mV					
ID-MATCH	Current Matching Between Any	V _{DX} =3.6V		0.5		%	
	Two Outputs						
lq	Quiescent Supply Current	$3.0V \leq V_{IN} \leq 4.2V$, Active, No Load,		3.2		mA	
		Rset=OPEN					
lsd	Shutdown Supply Current	$3.0V \leq V_{IN} \leq 5.5V$, Shutdown			1	υA	
I _{PULL-EN}	EN pull-high current (EMD2795)	0		3.2		υA	
V_{CP}	1.5X to 1.0X Threshold			4.75		V	
V _{CPH}	1.0X to 1.5X Hysteresis			300		mV	
VIH	EN Input Logic High (EMD2794)			1.0			
	EN Input Logic High (EMD2795)			0.8V _{IN}			
VIL	EN Input Logic Low (EMD2794)			0.4		V	
	EN Input Logic Low (EMD2795)			0.2V _{IN}			
R _{BRGT}	BRGT Input Resistance			240		kΩ	
fsw	Switching Frequency	$3.0V \leq V_{IN} \leq 5.5V$		1.2		MHz	

 $V_{EN}=V_{IN}$ (EMD2795: $V_{EN}=0V$).

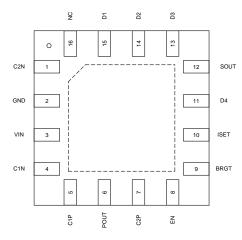
Note 1: Absolute maximum ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.

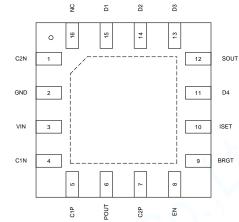
Note 2: Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at TJ=150°C (typ.) and disengages at TJ=140°C (typ.).



Preliminary EMD2794/EMD2795

Pin Descriptions





TQFN-16 pin 3mm x 3mm, Top View

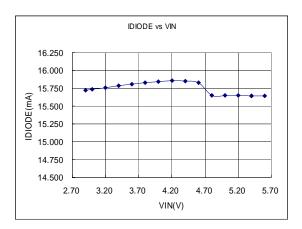
FBP-16 pin 3mm x 3mm, Top View

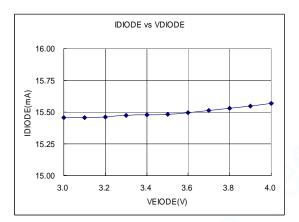
Pin Name	Pin Order	Descriptions
C2N	1	Negative terminal of C2
GND	2	Power supply ground input
VIN	3	Power supply voltage input
C1N	4	Negative terminal of C1
C1P	5	Positive terminal of C1
POUT	6	Charge pump output. Connect 1uF ceramic capacitor at this pin.
C2P	7	Positive terminal of C2
EN	8	The EMD2794 has an active-low shutdown pin (LOW = shutdown, HIGH = operating). The
		EMD2795 has an active-high shutdown pin (HIGH = shutdown, LOW = operating) that has a
		pull-up to V _{IN} .
BRGT	9	Variable voltage input controls output current
ISET	10	Current Sense Input. Connect 1% resistor to ground to set constant current through LED.
D4	11	Current source outputs. Connect directly to LED.
SOUT	12	Charge pump input. Connect directly to pin POUT. (Please refer to typical application.)
D3	13	Current source outputs. Connect directly to LED.
D2	14	Current source outputs. Connect directly to LED.
D1	15	Current source outputs. Connect directly to LED.
NC	16	
EP	EP	Exposed paddle (bottom); connect to GND directly beneath package.

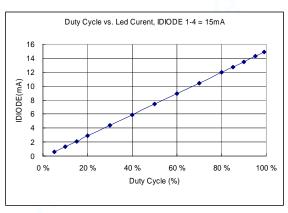


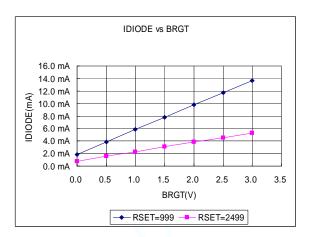
Typical Performance Characteristics

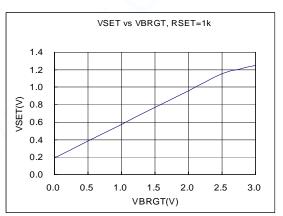
Unless otherwise specified, C1=C2=CIN=COUT, VIN=3.6V, BRGT=0V, RSET=124 Ω

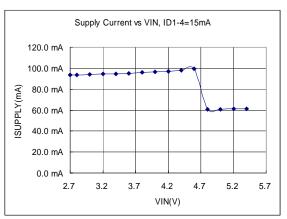








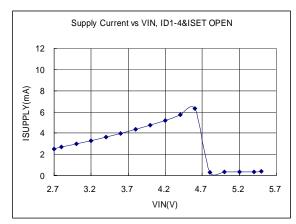


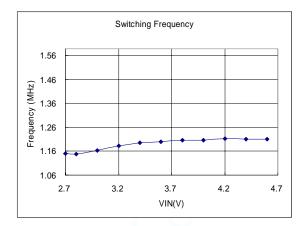




Typical Performance Characteristics

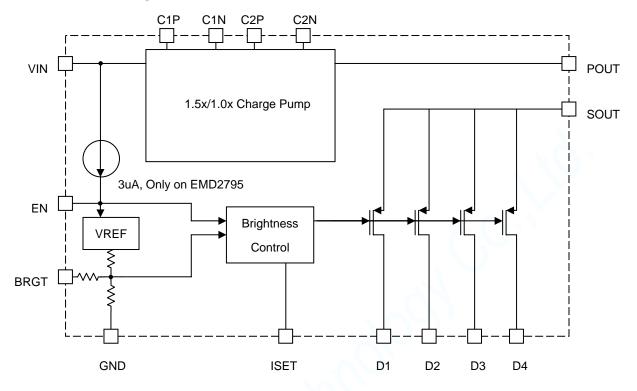
Unless otherwise specified, C1=C2=CIN=COUT, VIN=3.6V, BRGT=0V, RSET=124 Ω







Function Block Diagram



Application Information

CIRCUIT DESCRIPTION

The EMD2794/5 is a 1.5x/1.0x charge pump with four matched constant current outputs, each capable of driving up to 20mA. This device operates over the extended Li-Ion battery range from 2.7V to 5.5V. At input voltages below 4.75V (typ.), the charge-pump provides the needed voltage to drive high forward voltage drop LEDs by stepping up the POUT voltage 1.5 times the input voltage. The charge pump provides a voltage on POUT equal to the input voltage when the input voltage is at or above 4.75V (typ.). The EMD2794/5 can drive up to 80mA through any combination of LEDs connected to the constant current outputs D1-D4.

The EMD2794/5 uses a resistor connected to the ISET pin to set a reference current. This reference current is then multiplied 10 times to each constant current output.

The LED brightness can then be controlled by analog and/or digital methods. Applying an analog voltage in the

range of 0V to 3.0V to the Brightness pin (BRGT) adjusts the dimming profile of the LEDs. The digital technique uses a PWM (Pulse Width Modulation) signal applied to the Enable pin (EN).

SOFT START

Soft start is implemented internally by ramping the reference voltage more slowly than the applied voltage. During soft start, the current through the LED outputs will ramp up in proportion to the rate that the reference voltage is being ramped up.

SHUTDOWN MODE

The enable pin (EN) disables the device and reduces the quiescent current to below than 1uA. The EMD2795 has an active-low enable pin (HIGH = shutdown, LOW = operating). An internal pull-up is connected between EN and VIN of the EMD2795. This allows the use of open-drain logic control of the EMD2795 shutdown. The EMD2795 EN



pin can also be driven with a rail-to-rail CMOS logic signal. The EMD2794 has an active-high enable pin (LOW = shutdown, HIGH = operating). The EMD2794 EN pin can be driven with a low-voltage CMOS logic signal (1.5V logic, 1.8V logic, etc). There is no internal pull-up or pull-down on the EN pin of the EMD2794.

CAPACITOR SELECTION

The EMD2794/5 requires 4 external capacitors for proper operation. Surface-mount multi-layer ceramic capacitors are recommended. These capacitors are small, inexpensive and have very low equivalent series resistance (ESR, $\leq 15m\Omega$ typ.).

For most applications, ceramic capacitors with X7R or X5R temperature characteristic are preferred for use with the EMD2794/5. These capacitors have tight capacitance tolerance (as good as $\pm 10\%$), hold their value over temperature (X7R: $\pm 15\%$ over -55° C to 125° C; X5R: $\pm 15\%$ over -55° C to 85° C), and typically have little voltage coefficient. Capacitors with Y5V or Z5U temperature characteristic are generally not recommended for use with the EMD2794/5.

LED SELECTION

The EMD2794/5 is designed to drive LEDs with a forward voltage of about 3.0V to 4.0V. The typical and maximum diode forward voltage depends highly on the manufacturer and their technology. Forward current matching is assured over the LED process variations due to the constant current output of the EMD2794/5.

ISET AND BRGT PINS

An external resistor, RSET, is connected to the ISET pin to set the current to be mirrored in each of the LED outputs. The internal current mirror sets each LED output current with a 10:1 ratio to the current through RSET. The current mirror circuitry matches the current through each LED to within

0.5%.

In addition to RSET, a voltage may be applied to the VBRGT pin to vary the LED current. By adjusting current with the Brightness pin (BRGT), the brightness of the LEDs can be smoothly varied. Applying a voltage on BRGT between 0 to 3 volts will linearly vary the LED current. An equation for approximating the LED current is:

ILED=(0.188 + 0.385 * VBRGT) / RSET * 10 Amps

Iled CURRENT SELECTION PROCEDURES

The following procedures illustrate how to set and adjust output current levels. For constant brightness or analog brightness control, go to "Brightness control using BRGT". Otherwise refer to "Brightness control using PWM".

Brightness Control Using PWM

1. Set the BRGT pin to OV.

- Determine the maximum desired ILED current. Use the ILED equation to calculate RSET by setting BRGT to 0V or use Table 1 to select a value for RSET when BRGT equals 0V.
- Brightness control can be implemented by pulsing a signal at the EN pin. LED brightness is proportional to the duty cycle (D) of the PWM signal. For linear brightness control over the full duty cycle adjustment range, the PWM frequency (f) should be limited to accommodate the turn-on time (TON = 100µs) of the device.

$D \times (1/f) > TON$

fMAX = DMIN ÷ TON

If the PWM frequency is much less than 100Hz, flicker may be seen in the LEDs. For the EMD2794, zero duty cycle will turn off the LEDs and a 50% duty cycle will result in an average ILED being half of the programmed LED current. For example, if RSET is set to program 15mA, a 50% duty cycle will result in an average ILED of 7.5mA. For the EMD2795 however,



100% duty cycle will turn off the LEDs and a 50% duty cycle will result in an average ILED being half the programmed LED current.

		LED Current					
BRGT	5mA	10mA	15mA	20mA			
0.0V	37 6Ω	188Ω	125Ω	94 Ω			
0.5V	761 Ω	38 1 Ω	254Ω	190 Ω			
1.0V	1.15kΩ	573Ω	382 Ω	287 Ω			
1.5V	1.53kΩ	766Ω	510Ω	383 Ω			
2.0V	1 .92 kΩ	958 Ω	639 Ω	479 Ω			
2.5V	2.30 Ω	1.15kΩ	767Ω	575Ω			
3.0V	2.69kΩ 1.34kΩ		895 Ω	672 Ω			

Table 1 Rset Values

Brightness Control Using BRGT

- Choose the maximum ILED desired and determine the max voltage to be applied to the BRGT pin. For constant brightness, set BRGT to a fixed voltage between 0V to 3V.
- 2. Use the ILED equation above to calculate RSET.
- Use Table 2 as a reference for the dimming profile of the LEDs, when BRGT ranges from 0V to 3V.

	LED Current						
BRGT	2.67kΩ	Ω 1.33kΩ 909Ω		665Ω			
0.0V	0.7mA	1.4mA	2.1mA	2.8mA			
0.5V	1.4mA	nA 4.3mA 6.3mA		5.7mA			
1.0V	2.1mA			8.6mA			
1.5V	2.9mA			11.5mA			
2.0V	3.6mA	7.2mA	10.5mA	14.4mA			
2.5V	4.3mA			17.3mA			
3.0V	5.0mA			20.2mA			

Table 2 LED Current

CHARGE PUMP OUTPUT AND INPUT (Pout AND Sout)

The EMD2794/5 charge pump is an unregulated switched capacitor converter with a gain of 1.5. The voltage at the output of the pump (the POUT pin) is nominally 1.5 x VIN. This rail can be used to deliver additional current to other circuitry. Since POUT is unregulated, driving LEDs directly off POUT is usually practical only with a fixed input voltage. If the input voltage is not fixed (Li-Ion battery, for example), using a linear regulator between the POUT pin and the LEDs is recommended.

LED drivers use power supply from pin SOUT. To maintain normal operation of LED current output, connect pin SOUT directly to POUT on PCB.

PARALLEL DX OUTPUTS FOR INCREASED CURRENT DRIVE

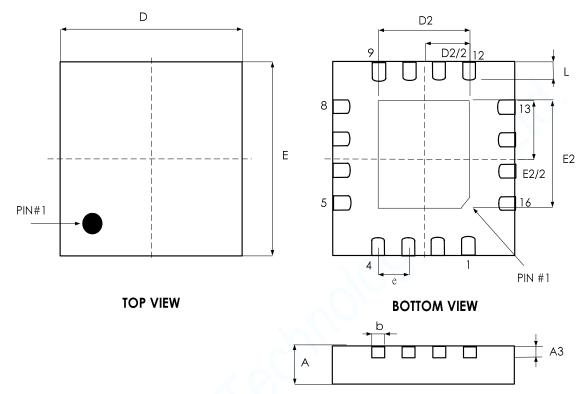
Outputs D1 through D4 may be connected together in any combination to drive higher currents through fewer LEDs. For example, outputs D1 and D2 can be connected together to drive one LED while D3 and D4 are connected together to drive a second LED.

THERMAL PROTECTION

When the junction temperature exceeds 150°C (typ.), the EMD2794/5 internal thermal protection circuitry disables the part. This feature protects the device from damage due to excessive power dissipation. The device will recover and operate normally when the junction temperature falls below 140°C (typ.). It is important to have good thermal conduction with a proper layout to reduce thermal resistance.



Package Description TQFN-16



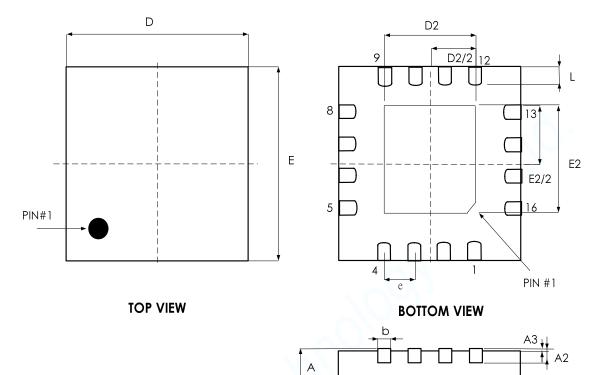
SIDE VIEW

	СОММОН						
Symbol	DIMENSIONS MILLIMETER			DIMENSIONS INCH			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.700	0.750	0.800	0.027	0.029	0.031	
A3	0.195	0.203	0.211	0.0077	0.0080	0.0083	
b	0.180	0.230	0.300	0.007	0.009	0.012	
D	2.950	3.000	3.050	0.116	0.118	0.120	
E	2.950	3.000	3.050	0.116	0.118	0.120	
е	0.50 BSC			0.020 BSC			
L	0.350	0.400	0.450	0.014	0.016	0.018	
D2	1.500	1.625	1.750	0.059	0.064	0.069	
E2	1.500	1.625	1.750	0.059	0.064	0.069	



SIDE VIEW

FBP-16



SYMBOL	DIMENSIONS MILLIMETER				
STRIDUL	MIN.	NOM.	MAX.		
A	0.800	0.850	0.900		
A2	0.153	0.203	0.253		
A3	0.000	0.025	0.050		
b D	0.180	0.230	0.300		
	2.900	3.000	3.100		
E	2.900	3.000	3.100		
е		0.500 BSC			
L	0.300	0.400	0.500		
D2	1.600	1.700	1.800		
E2	1.600	1.700	1.800		



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